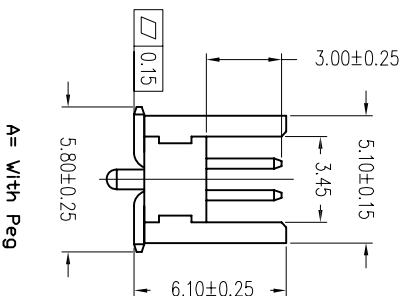
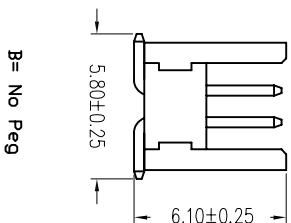
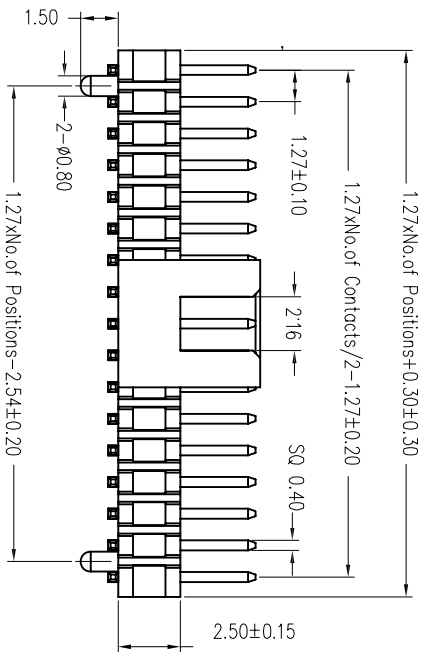


Recommended PC Board Layout

SPECIFICATIONS:

- Current Rating: 1Amp
- Insulation Resistance: 1000MΩ Min.
- Dielectric Withstanding: 500V AC/DC
- Contact Resistance: 20mΩ Max.
- Operating Temperature: -40°C to +105°C
- Contact Material: Phosphor Bronze
- Insulation Material: Polyester, UL 94V-0
- Plating: Gold, Tin or Selective over Nickel
- Solderability: IR Reflow 260°C for 10sec
Wave 230C for 5~10sec
Manual solder 350°C for 3~5sec



How to order

MCDC07-X X X X X X
1 2 3 4 5 6

- Series No
- No. Of Pin Per Row
05-50
- Contact Plating
G1=Gold flash
T1=Tin
S1=Gold/tin
- Insulator Material
L=LCP *
- Loading Peg
A= With peg
B= No peg
C= Packing
- Packing
C=Tube

* for standard



RSK TECHNOLOGY CO., LTD
www.rsk-tech.com

Tel: +86 755 28216712
Fax: +86 755 26982309

Website: www.rsk-tech.com
Email: info@rsk-tech.com

TITLE: Pin Header, 1.27 Pitch, Dual row,
Vertical SMT Type, with key

A4

APPD.: Xiao Jian PART NO.: MCDC07-XXXX

CHKD.: Wang Zhijun DWG. NO.: MCDC07-XXXX

DR.: Li Guoming REV.: 1.0 DATE: 2011-05-14

X.: ±0.30 Y.: ±5.0°
XX: ±0.20 XX: ±3.0°
XXX: ±0.15 XXX: ±1.0°

UNIT: mm
SCALE: 1:1
SHEET: 1/1

1.3		
1.2		
1.1		
1.0	RELEASED	Li GM
REV	ECN, ND.	DR, BY

1	2	3
4	5	6
7	8	

DATE

DATE

DATE

DATE